



PATENT YOR920030206US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Larry Shungwei Mok

Serial Number

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, ,

10/784,624

Filing Date

February 23, 2004

Examiner

:

Tho V. Duong

Group Art Unit

:

3753

For

HEAT DISSIPATION INTERFACE FOR

SEMICONDUCTOR STRUCTURES

TO: The Honorable Commissioner of Patents and Trademarks Post Office Box 1450 Alexandria, VA 22313-1450

In response to the Official Action dated October 17, 2007, which was a requirement for restriction, Applicant hereby elects "Species A" of Figures 1 - 3 which are covered in Claims 1 - 6.

Please address all correspondence in this application to the undersigned as attorney of record at 6136 West Kimberly Way, Glendale, AZ 85308.

Respectfully Submitted,

Thomas A. Beck

Registration No. 20,816 6136 West Kimberly Way

Glendale, AZ 85308

(623) 466-0080

I hereby certify that this paper is being transmitted via the United States Postal Service, in a sealed envelope, postage prepaid, on the date indicated below, addressed to Commissioner of Patents & Trademarks, Post Office Box 1450,

Alexandria, XA 22313-1450

Thomas A. Beck

Date: November 16, 2007